

## 6 CHANNEL VOLUME CONTROLLER

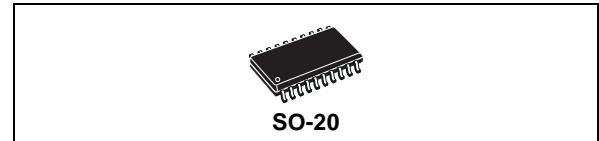
### 1 FEATURES

- 6 CHANNEL INPUTS
- 6 CHANNEL OUTPUTS
- VOLUME ATTENUATION RANGE OF 0 TO -79dB
- VOLUME CONTROL IN 1.0dB STEPS
- 6 CHANNEL INDEPENDENT CONTROL
- ALL FUNCTION ARE PROGRAMMABLE VIA SERIAL BUS

### 2 DESCRIPTION

The TDA7448 is a 6 channel volume controller for quality audio applications in Multi-Channels Audio Systems

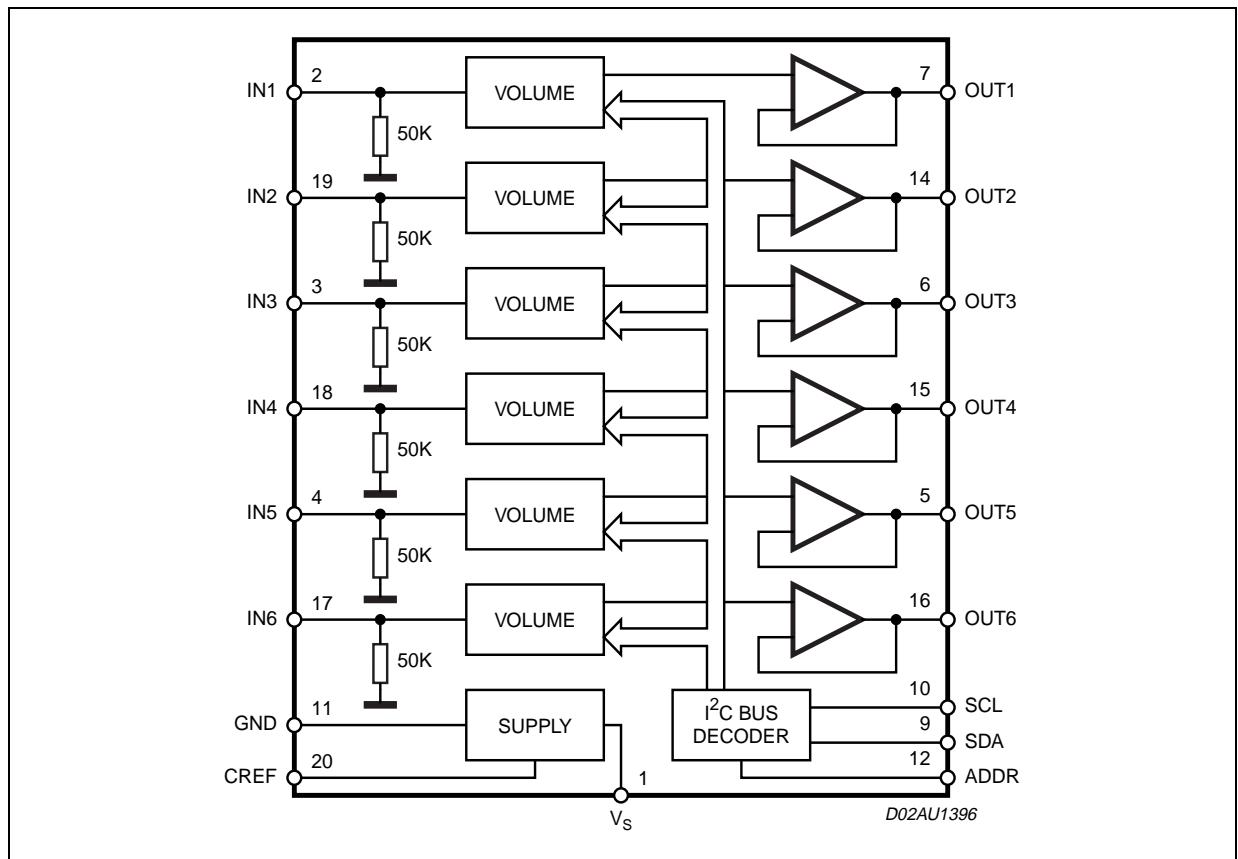
**Figure 1. Package**



**Table 1. Order Codes**

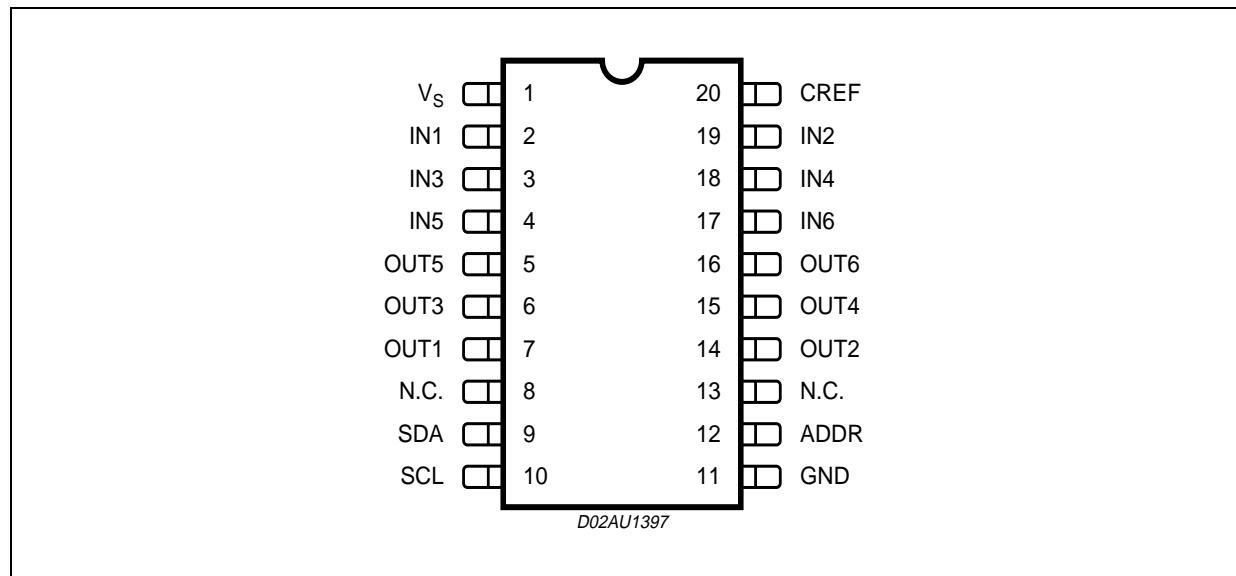
Part Number	Package
TDA7448	SO-20
TDA744813TR	Tape & Reel

**Figure 2. Block Diagram**



**Table 2. Absolute Maximum Ratings**

Symbol	Parameter	Value	Unit
$V_S$	Operating Supply Voltage	10.5	V
$T_{amb}$	Operating Ambient Temperature	0 to 70	°C
$T_{stg}$	Storage Temperature Range	-55 to 150	°C

**Figure 3. Pin Connection (Top view)****Table 3. Thermal Data**

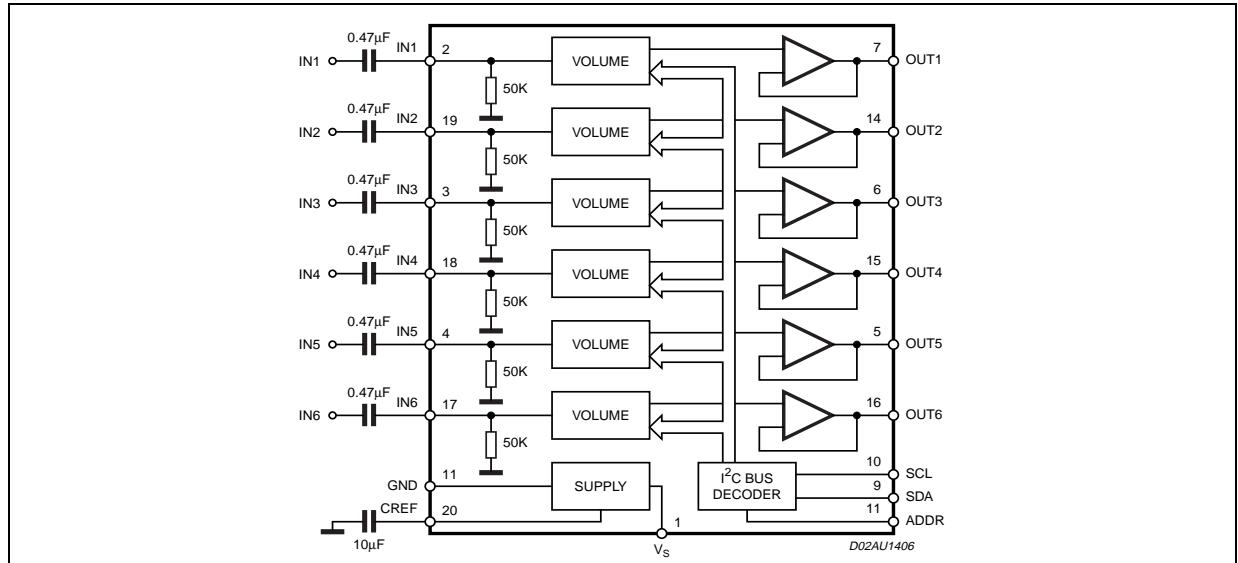
Symbol	Parameter	Value	Unit
$R_{th\ j\-\ pin}$	thermal Resistance junction-pins	150	°C/W

**Table 4. Quick Reference Data**

Symbol	Parameter	Min.	Typ.	Max.	Unit
$V_S$	Supply Voltage	4.75	9	10	V
$V_{CL}$	Max Input Signal Handling	2			Vrms
THD	Total Harmonic Distortion $V = 1\text{Vrms}$ $f = 1\text{KHz}$		0.01	0.1	%
S/N	Signal to Noise Ratio $V_{out} = 1\text{Vrms}$		100		dB
$S_C$	Channel Separation $f = 1\text{KHz}$		90		dB
	Volume Control (1dB step)	-79		0	dB
	Mute Attenuation		90		dB

**Table 5. Electrical Characteristics**(refer to the test circuit  $T_{amb} = 25^{\circ}C$ ,  $V_S = 9V$ ,  $R_L = 10K\Omega$ ,  $R_G = 600\Omega$ , unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
<b>SUPPLY</b>						
$V_S$	Supply Voltage		4.75	9	10	V
$I_S$	Supply Current			7		mA
SVR	Ripple Rejection			80		dB
<b>INPUT STAGE</b>						
$R_{IN}$	Input Resistance		35	50	65	$K\Omega$
$V_{CL}$	Clipping Level	THD = 0.3%	2	2.5		Vrms
$S_{IN}$	Input Separation	The selected input is grounded through a $2.2\mu$ capacitor		90		dB
<b>VOLUME CONTROL</b>						
$C_{RANGE}$	Control Range			79		dB
$A_{VMAX}$	Max. Attenuation			79		dB
$A_{STEP}$	Step Resolution		0.5	1	1.5	dB
$E_A$	Attenuation Set Error	$A_V = 0$ to $-24$ dB	-1	0	1	dB
		$A_V = -24$ to $-79$ dB	-2.0	0	2.0	dB
$E_T$	Tracking Error	$A_V = 0$ to $-24$ dB	-1	0	1	dB
		$A_V = -24$ to $-79$ dB	-2	0	2	dB
$V_{DC}$	DC Step	adjacent attenuation steps	-3	0	3	mV
$A_{mute}$	Mute Attenuation			90		db
<b>AUDIO OUTPUTS</b>						
$V_{CLIP}$	Clipping Level	THD = 0.3%	2	2.5		Vrms
$R_L$	Output Load Resistance		2			$K\Omega$
$V_{DC}$	DC Voltage Level			4.5		V
<b>GENERAL</b>						
$E_{NO}$	Output Noise	BW = 20Hz to 20KHz All gains = 0dB, Flat		10	15	$\mu$ V
S/N	Signal to Noise Ratio	All gains = 0dB; $V_O = 1$ Vrms		100		dB
$S_c$	Channel Separation left/Right		80	90		dB
THD	Distortion	$A_V = 0$ ; $V_I = 1$ Vrms		0.01	0.1	%
<b>BUS INPUT</b>						
$V_{II}$	Input Low Voltage				1	V
$V_{IH}$	Input High Voltage		2.5			V
$I_{IN}$	Input Current	$V_{IN} = 0.4V$	-5		5	$\mu$ A
$V_O$	Output Voltage SDA Acknowledge	$I_O = 1.6$ mA		0.4	0.8	V

**Figure 4. Test circuit**

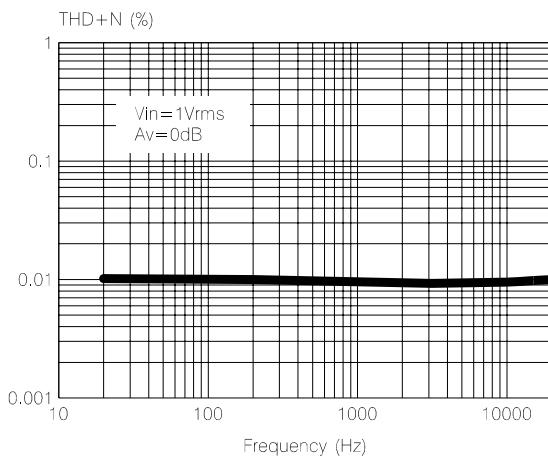
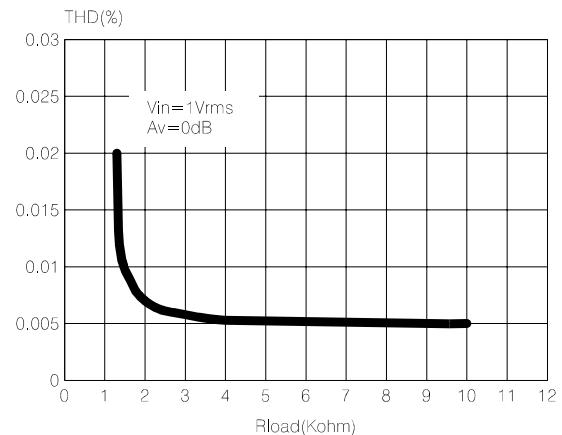
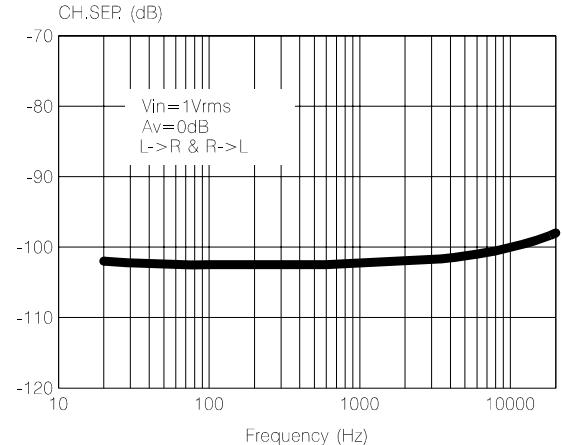
### 3 APPLICATION SUGGESTIONS

The volume control range is 0 to -79dB, by 1dB step resolution.

The very high resolution allows the implementation of systems free from any noise acoustical effect.

#### 3.1 CREF

The suggested 10µF reference capacitor (CREF) value can be reduced to 4.7µF if the application requires faster power ON.

**Figure 5. THD vs. frequency****Figure 6. THD vs. R<sub>LOAD</sub>****Figure 7. Channel separation vs. frequency**

## 4 I<sup>2</sup>C BUS INTERFACE

Data transmission from microprocessor to the TDA7448 and vice versa takes place through the 2 wires I<sup>2</sup>C BUS interface, consisting of the two lines SDA and SCL (pull-up resistors to positive supply voltage must be connected).

### 4.1 Data Validity

As shown in fig. 8, the data on the SDA line must be stable during the high period of the clock. The HIGH and LOW state of the data line can only change when the clock signal on the SCL line is LOW.

### 4.2 Start and Stop Conditions

As shown in fig. 9 a start condition is a HIGH to LOW transition of the SDA line while SCL is HIGH. The stop condition is a LOW to HIGH transition of the SDA line while SCL is HIGH.

### 4.3 Byte Format

Every byte transferred on the SDA line must contain 8 bits. Each byte must be followed by an acknowledge bit. The MSB is transferred first.

### 4.4 Acknowledge

The master (μP) puts a resistive HIGH level on the SDA line during the acknowledge clock pulse (see fig. 10). The peripheral (audio processor) that acknowledges has to pull-down (LOW) the SDA line during this clock pulse.

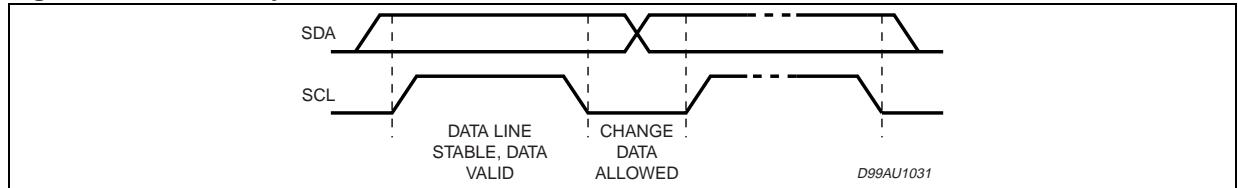
The audio processor which has been addressed has to generate an acknowledge after the reception of each byte, otherwise the SDA line remains at the HIGH level during the ninth clock pulse time. In this case the master transmitter can generate the STOP information in order to abort the transfer.

### 4.5 Transmission without Acknowledge

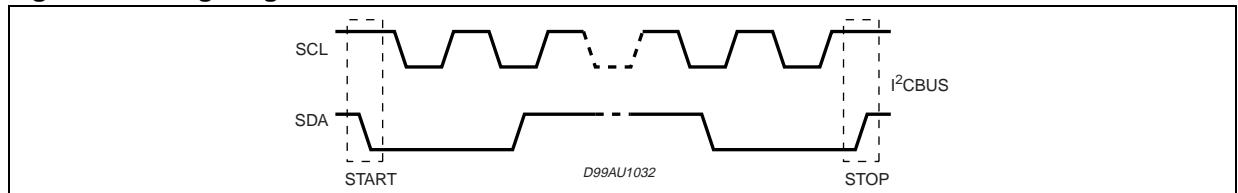
Avoiding to detect the acknowledge of the audio processor, the μP can use a simpler transmission: simply it waits one clock without checking the slave acknowledging, and sends the new data.

This approach of course is less protected from misworking.

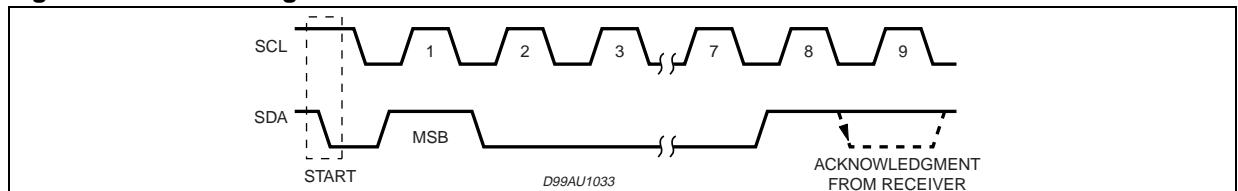
**Figure 8. Data Validity on the I<sup>2</sup>CBUS**



**Figure 9. Timing Diagram of I<sup>2</sup>CBUS**



**Figure 10. Acknowledge on the I<sup>2</sup>CBUS**

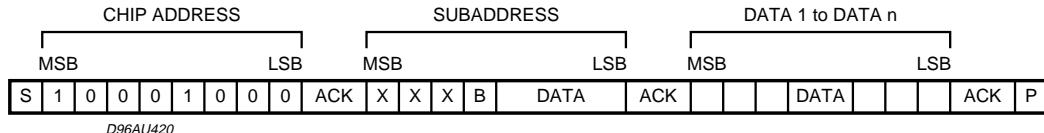


## 5 SOFTWARE SPECIFICATION

### Interface Protocol

The interface protocol comprises:

- A start condition (S)
- A chip address byte, containing the TDA7448 address
- A subaddress bytes
- A sequence of data (N byte + acknowledge)
- A stop condition (P)

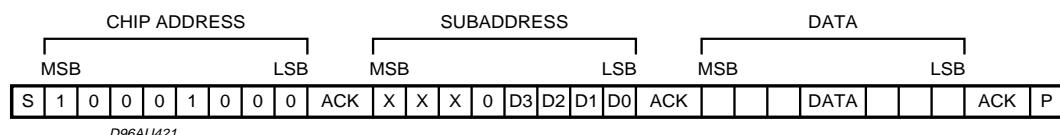


ACK = Acknowledge; S = Start; P = Stop; A = Address; B = Auto Increment

### 5.1 EXAMPLES

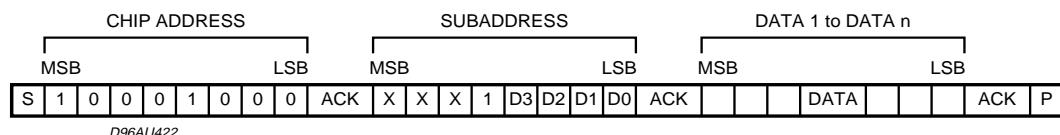
#### 5.1.1 No Incremental Bus

The TDA7448 receives a start condition, the correct chip address, a subaddress with the B = 0 (no incremental bus), N-data (all these data concern the subaddress selected), a stop condition.



#### 5.1.2 Incremental Bus

The TDA7448 receives a start conditions, the correct chip address, a subaddress with the B = 1 (incremental bus): now it is in a loop condition with an autoincrease of the subaddress whereas SUBADDRESS from "XXX1000" to "XXX1111" of DATA are ignored. The DATA 1 concern the subaddress sent, and the DATA 2 concern the subaddress sent plus one in the loop etc, and at the end it receives the stop condition.



### 5.2 DATA BYTES

Address= 88 (HEX) (10001000): ADDR open; 8A (HEX) (10001010): connect to supply

Table 6. FUNCTION SELECTION: subaddress

MSB								LSB	SUBADDRESS
	D7	D6	D5	D4	D3	D2	D1		
X	X	X	B	0	0	0	0	0	SPEAKER ATTENUATION OUT 1
X	X	X	B	0	0	0	0	1	SPEAKER ATTENUATION OUT 2
X	X	X	B	0	0	1	0	0	SPEAKER ATTENUATION OUT 3
X	X	X	B	0	0	1	1	1	SPEAKER ATTENUATION OUT 4
X	X	X	B	0	1	0	0	0	SPEAKER ATTENUATION OUT 5
X	X	X	B	0	1	0	1	1	SPEAKER ATTENUATION OUT 6
X	X	X	B	0	1	1	0	0	NOT USED"
X	X	X	B	0	1	1	1	1	NOT USED

B=1: INCREMENTAL BUS; ACTIVE

B=0: NO INCREMENTAL BUS

X= DON'T CARE

In Incremental Bus Mode, the three “not used” functions must be addressed in any case. For example to refresh “Speaker Attenuation 3 = 0dB and Speaker Attenuation 6 = -40 dB”, the following bytes must be sent:

**Table 7.**

SUBADDRESS		XXX10010
SPEAKER ATTENUATION OUT 1		XXXXXXX
SPEAKER ATTENUATION OUT 2		XXXXXXX
SPEAKER ATTENUATION OUT 3		00000000
SPEAKER ATTENUATION OUT 4		XXXXXXX
SPEAKER ATTENUATION OUT 5		XXXXXXX
SPEAKER ATTENUATION OUT 6		00101111

**Table 8. SPEAKER ATTENUATION SELECTION**

MSB								LSB	SPEAKER ATTENUATION
	D7	D6	D5	D4	D3	D2	D1		
					0	0	0		0dB
					0	0	1		-1dB
					0	1	0		-2dB
					0	1	1		-3dB
					1	0	0		-4dB
					1	0	1		-5dB
					1	1	0		-6dB
					1	1	1		-7dB
<hr/>									
0	0	0	0	0					-0dB
0	0	0	0	1					-8dB
0	0	0	1	0					-16dB
0	0	0	1	1					-24dB
0	0	1	0	0					-32dB
0	0	1	0	1					-40dB
0	0	1	1	0					-48dB
0	0	1	1	1					-56dB
0	1								-64dB
1	0								-72dB
1	1								MUTE

value = 0 to -79dB and MUTE

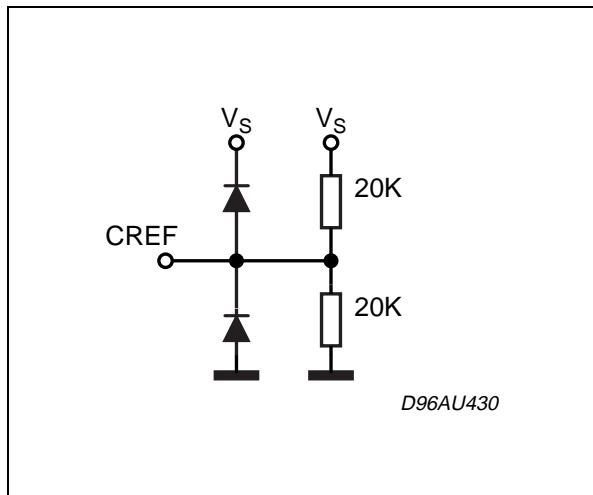
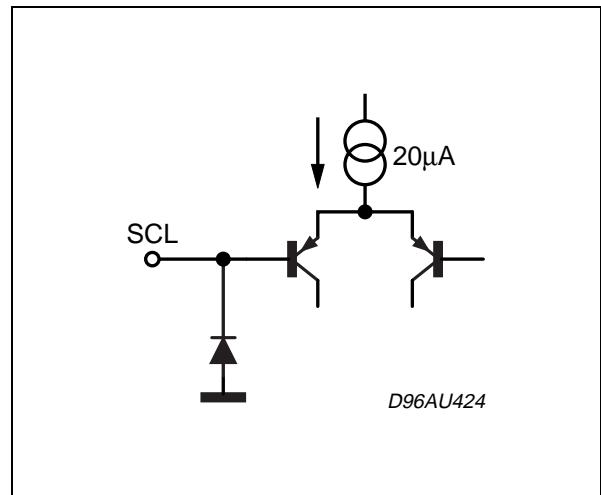
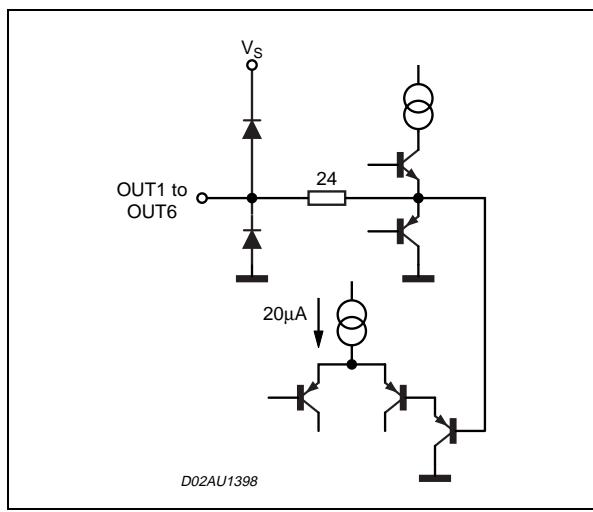
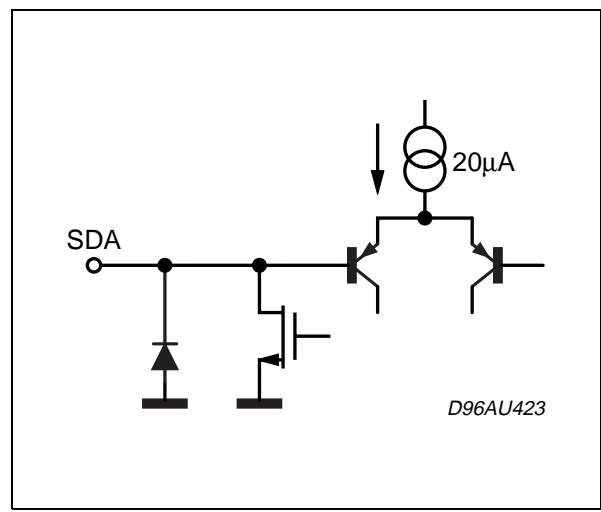
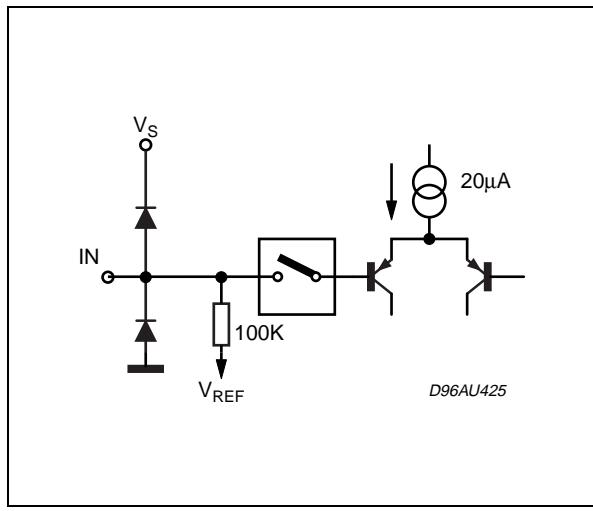
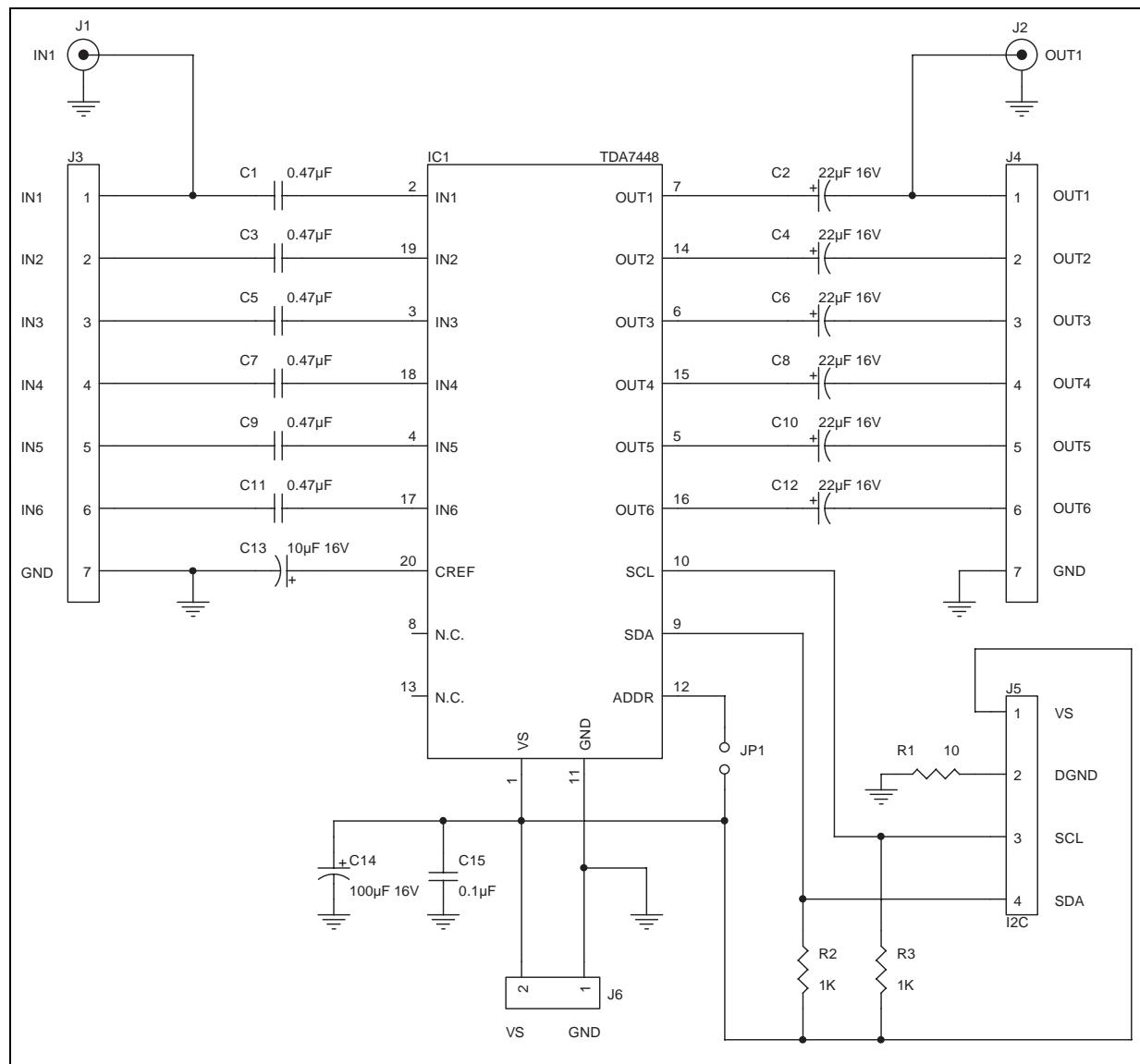
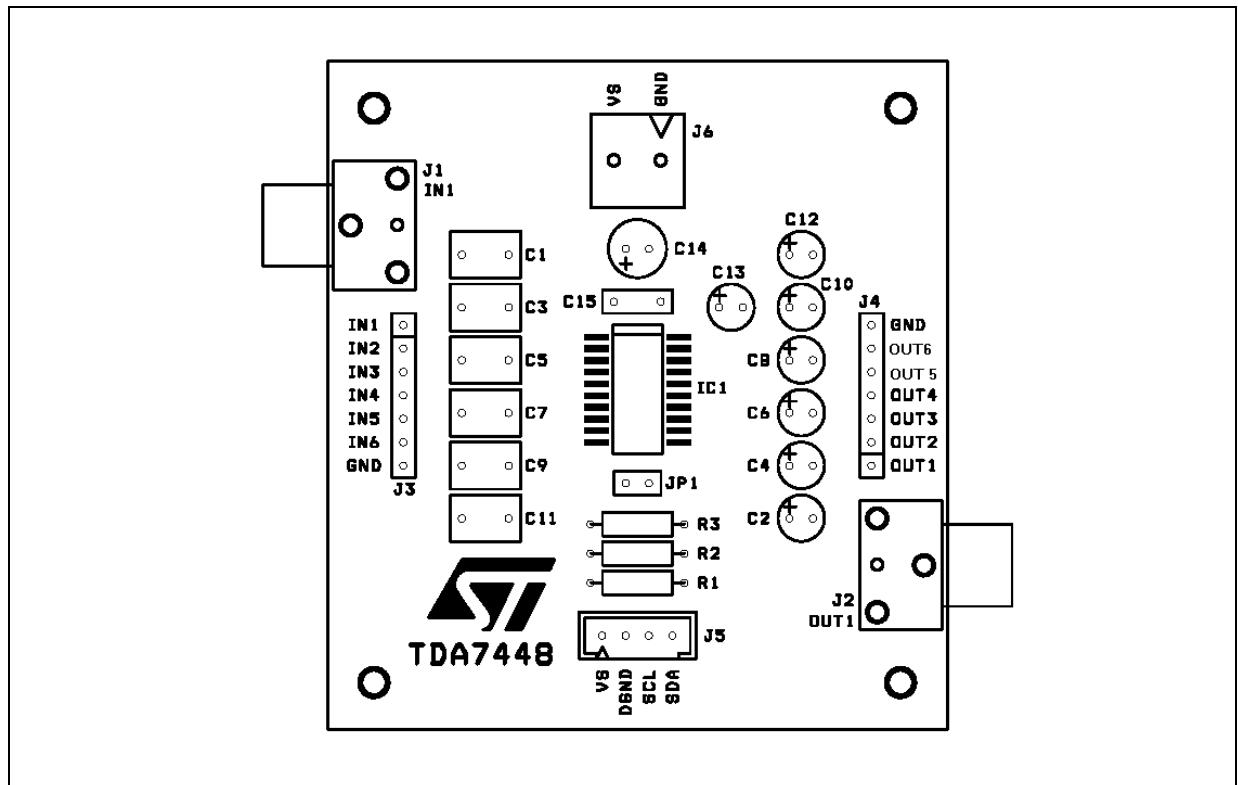
**Figure 11. PIN:20****Figure 14. PINS: 10****Figure 12. PINS: 5, 6, 7, 14, 15, 16****Figure 15. PINS: 9****Figure 13. PINS: 2, 3, 4, 17, 18, 19**

Figure 16. Test and Application Circuit



**Figure 17. Component Layout (65 x 72mm)**



**Figure 18. PC Board (Component side)**

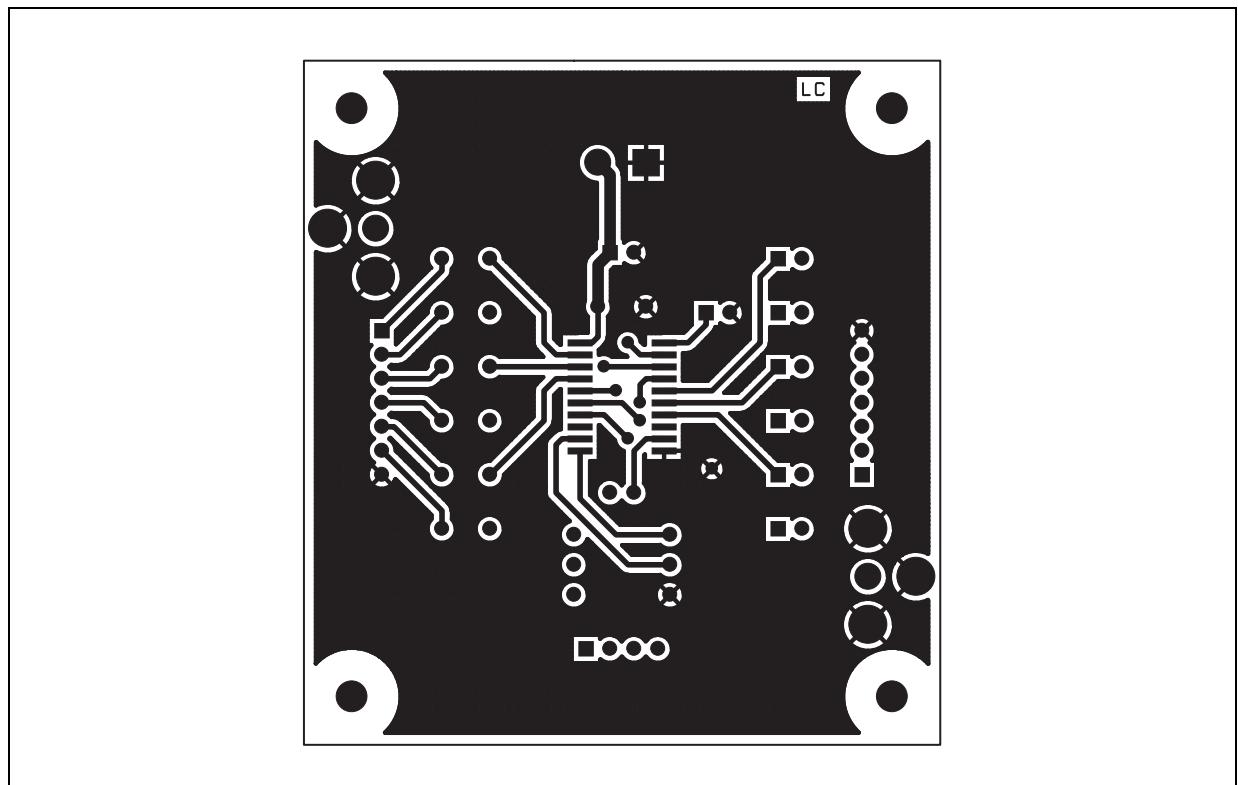


Figure 19. PC Board (Solder side)

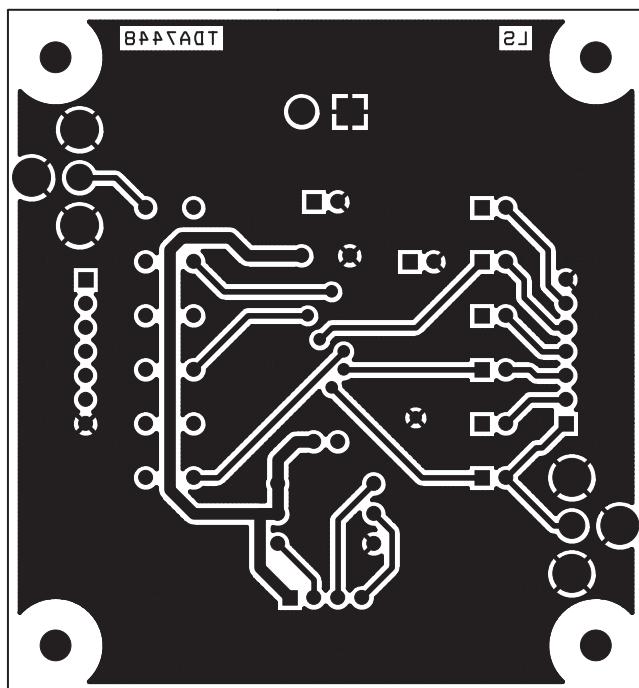
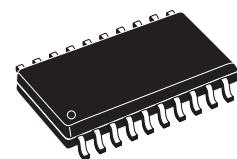


Figure 20. SO-20 Mechanical Data &amp; Package Dimensions

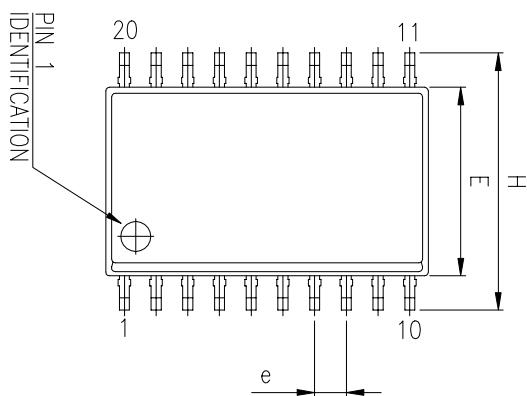
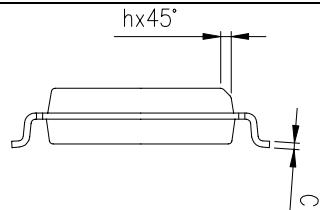
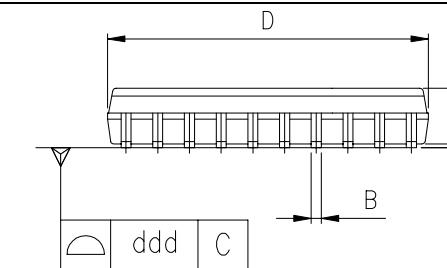
DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	2.35		2.65	0.093		0.104
A1	0.10		0.30	0.004		0.012
B	0.33		0.51	0.013		0.200
C	0.23		0.32	0.009		0.013
D <sup>(1)</sup>	12.60		13.00	0.496		0.512
E	7.40		7.60	0.291		0.299
e		1.27			0.050	
H	10.0		10.65	0.394		0.419
h	0.25		0.75	0.010		0.030
L	0.40		1.27	0.016		0.050
k	0° (min.), 8° (max.)					
ddd			0.10			0.004

(1) "D" dimension does not include mold flash, protusions or gate burrs. Mold flash, protusions or gate burrs shall not exceed 0.15mm per side.

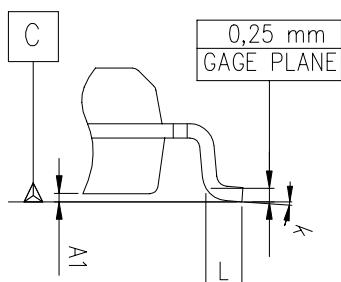
### OUTLINE AND MECHANICAL DATA



**SO20**



SEATING  
PLANE



0016022 D

**Table 9. Revision History**

Date	Revision	Description of Changes
January 2004	1	First Issue
June 2004	3	Modified the style-sheet in compliance with the last revision of the "Corporate Technical Publications Design Guide".

Information furnished is believed to be accurate and reliable. However, STMicroelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of STMicroelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. STMicroelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of STMicroelectronics.

The ST logo is a registered trademark of STMicroelectronics.

© 2004 STMicroelectronics - All rights reserved

**STMicroelectronics GROUP OF COMPANIES**

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States

[www.st.com](http://www.st.com)